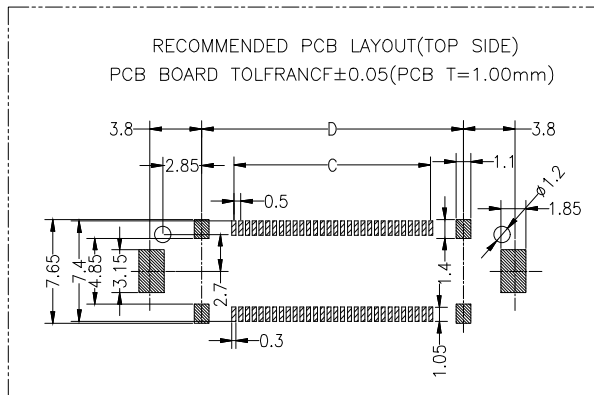
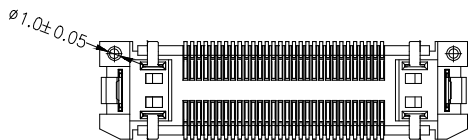
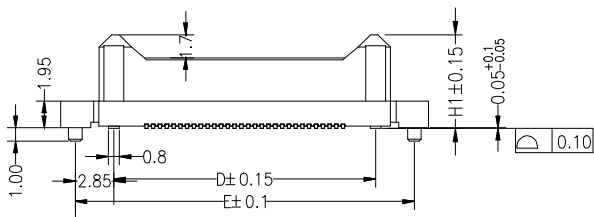
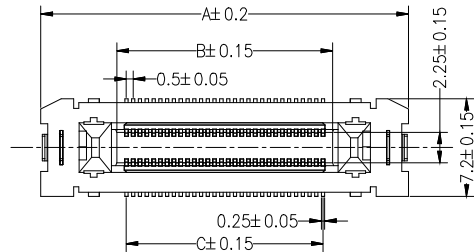


Ass'y High(H)	Plastic High	
	Male (H1)	Female (H2)
8.00	6.90	6.00
10.00	8.90	6.00

SPECIFICATIONS PERFORMANCE

Current Rating (信号端子) : 0.5A
Current Rating (电源端子) : 5A
Contact Resistance: 80mΩMax
Insulation Resistance: 500MΩMin
Withstand Volt: 200V AC/minute
Operating Temperature: -40°C to +105°C

Material

Contact: Phosphor Bronze, 3u" MIN Gold Plated In Contact Area,
Gold Flash Plated In Solder Area,
50u"~240u" Nickel Underplated Over all.
Ground: Brass, 80u" Min Matte Tin Plated Over
50u" Min Nickel Underplated Over all.
Housing: LCP Black, UL94V0
Max. Processing Temp: 230°C for 30~60 seconds
(260°C for 10 seconds)

PIN	A	B	C	D	E
30 Pin	19.60	8.50	7.00	12.80	17.50
50 Pin	24.60	13.50	12.00	17.80	22.50
60 Pin	27.10	16.00	14.50	19.30	25.00
80 Pin	32.10	21.00	19.50	24.30	30.00
100 Pin	37.10	26.00	24.50	29.30	35.00
120 Pin	42.10	31.00	29.50	34.30	40.00

Ordering Information

HC-PBB23L - NDP - 0.5V * - ** - 01

No. of Pins	Nature DP=Male	PITCH	High (H ±0.0)	Contact Plating
30~120Pin	0.5V=0.5mm	8=8.0mm	10=10.0mm	G2:3u" Gold
30~30Pin				S2:1u" Gold/Tin
50~50Pin				S1:3u" Gold/Tin
				S2:5u" Gold/Tin
				S3:10u" Gold/Tin
				S4:15u" Gold/Tin
				S5:30u" Gold/Tin

			GENERAL TOLERANCE	制图 DRAWING	深圳市华灿天禄电子有限公司 ShenzhenhuacantianluELECTRONICS CO.,LTD			
			DIM TOL	审核 CHECK	产品名称 TITLE	BTB 0.5 高频大电流 浮动式 贴片公座	版本 REV.	A
			X.X ±0.30	批准 APPROVAL	产品料号 PART NO.	HC-PBB23L-NDP-0.5VX-XX-01	单位 UNITS	mm
			X.XX ±0.20	比例 SCALE	材料 MATERIAL		页次 SHEET	1/1
			X.XXX ±0.10	投影 Projection				
序号 No.	变更内容 MODIFY CONTENT	日期 MODIFY DATE	Angle ±3.0°					